



1796

## PATENT APPLICATION

## IN THE U.S. PATENT AND TRADEMARK OFFICE

December 8, 2008

Applicants: Hironori KOBAYASHI et al

Title: RESIN COMPOSITION

Serial No.: 10/575 336

Group: 1796

Confirmation No.: 1816

Filed: April 7, 2006

Examiner: Dollinger

International Application No.: PCT/JP2004/014814

International Filing Date: September 30, 2004

Atty. Docket No.: 4700.P0326US

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

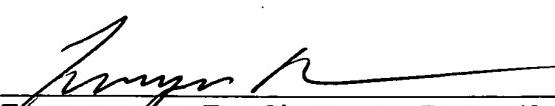
Herewith is an amendment in the above-identified application.

- Applicant claims small entity status. See 37 CFR 1.27.  
 The additional filing fee has been calculated as shown below:

For	No. Filed	No. Extra	(X) LG Entity	RATE	( ) SM Entity	Fee
Total Claims	(10 - 20 = 0)		x \$ 52.00		x \$ 26.00	
Indep. Claims	( 1 - 3 = 0)		x \$220.00		x \$110.00	
[ ] Multiple Dep. Claim			+ \$390.00		+ \$195.00	
* * * TOTAL FILING FEE * * *						\$ 0.00

- Pursuant to 37 CFR 1.136(a), please extend the shortened period for response by month(s). The extension fee is: \$.  
 A Check for \$ is enclosed to cover fees.  
 Please credit any overpayment, or charge any additional filing fee required under 37 CFR 1.16 or 1.17 by this communication, to Deposit Account No. 06-1382.

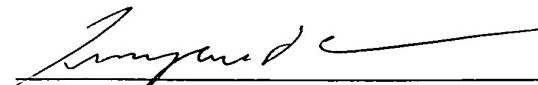
TFC/smd

  
Terryence F. Chapman Reg. No. 32 549

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 8, 2008.

130.10/08

  
Terryence F. Chapman